

TCR3DG series

300 mA CMOS Low Drop-Out Regulator with inrush current protection circuit

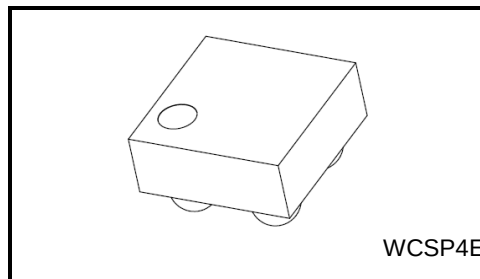
The TCR3DG series are CMOS general-purpose single-output voltage regulators with an on/off control input, featuring low dropout voltage, low output noise voltage and low inrush current.

These voltage regulators are available in fixed output voltages between 1.0 V and 4.5 V and capable of driving up to 300 mA.

They feature over-current protection, thermal shut down function, Inrush current protection circuit and Auto-discharge function.

The TCR3DG series are offered in the ultra small package WCSP4E(0.645mm x 0.645mm; t 0.40mm). It has a low dropout voltage of 160 mV (3.2 V output, $I_{OUT} = 300$ mA) with low output noise voltage of 38 μV_{rms} (2.5 V output) and a load transient response of only $\Delta V_{OUT} = \pm 80$ mV ($I_{OUT} = 1$ mA $\leftrightarrow$ 300 mA, $C_{OUT} = 1.0$ μF).

As small ceramic input and output capacitors can be used with the TCR3DG series, these devices are ideal for portable applications that require high-density board assembly such as cellular phones.



Weight : 0.34 mg (Typ.)

Features

- Low Drop-Out voltage
 $V_{IN}-V_{OUT} = 160$ mV (Typ.) at 3.2 V-output, $I_{OUT} = 300$ mA
- Low output noise voltage
 $V_{NO} = 38$ μV_{rms} (Typ.) at 2.5 V-output, $I_{OUT} = 10$ mA, 10 Hz $\leq f \leq 100$ kHz
- Fast load transient response ($\Delta V_{OUT} = \pm 80$ mV (Typ.) at $I_{OUT} = 1 \leftrightarrow 300$ mA, $C_{OUT} = 1.0$ μF)
- High ripple rejection (R.R = 70 dB (Typ.) at 2.5V-output, $I_{OUT} = 10$ mA, $f = 1$ kHz)
- Over current protection
- Thermal shut down function
- Inrush current protection circuit
- Auto-discharge function
- Pull down connection between CONTROL and GND
- Ceramic capacitors can be used ($C_{IN} = 1.0$ μF , $C_{OUT} = 1.0$ μF)
- Ultra small package WCSP4E (0.645 mm x 0.645 mm ; t 0.40 mm)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Input voltage	V _{IN}	6.0	V
Control voltage	V _{CT}	-0.3 to 6.0	V
Output voltage	V _{OUT}	-0.3 to V _{IN} + 0.3	V
Output current	I _{OUT}	300	mA
Power dissipation	P _D	800 (Note1)	mW
Operation temperature range	T _{opr}	-40 to 85	°C
Junction temperature	T _j	150	°C
Storage temperature range	T _{stg}	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note1: Rating at mounting on a board

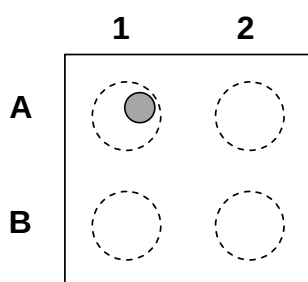
Board material: Glass epoxy(FR4)

Board dimension: 40mm x 40mm (both sides of board), t= 1.6mm

Metal pattern ratio: a surface approximately 50%, the reverse side approximately 50%

Through hole: diameter 0.5mm x 24

Pin Assignment (Top view)



	1	2
A	V _{IN}	V _{OUT}
B	CONTROL	GND

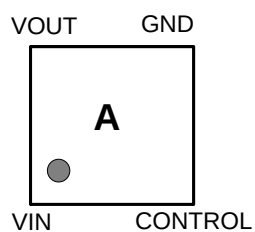
List of Products Number, Output voltage and Marking

Product No.	Output voltage (V)(Typ.)	Marking	Product No.	Output voltage (V)(Typ.)	Marking
TCR3DG10	1.0	E	TCR3DG285*	2.85	R
TCR3DG11*	1.1	F	TCR3DG30*	3.0	T
TCR3DG12	1.2	H	TCR3DG31*	3.1	U
TCR3DG13*	1.3	J	TCR3DG32	3.2	A
TCR3DG135*	1.35	K	TCR3DG33	3.3	B
TCR3DG18*	1.8	L	TCR3DG35*	3.5	V
TCR3DG25*	2.5	P	TCR3DG36*	3.6	C
TCR3DG28*	2.8	W	TCR3DG45*	4.5	D

Please ask your local retailer about the devices with (*) or other output voltages.

Top Marking (top view)

Example: TCR3DG32 (3.2 V output)



Electrical Characteristics

(Unless otherwise specified, $V_{IN} = V_{OUT} + 1\text{ V}$, $I_{OUT} = 50\text{ mA}$, $C_{IN} = 1.0\text{ }\mu\text{F}$, $C_{OUT} = 1.0\text{ }\mu\text{F}$, $T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition		Min	Typ.	Max	Unit
Output voltage accuracy	V_{OUT}	$I_{OUT} = 50\text{ mA}$ (Note 2)	$V_{OUT} < 1.8\text{ V}$	-18	—	+18	mV
			$1.8\text{ V} \leq V_{OUT}$	-1.0	—	+1.0	%
Input voltage	V_{IN}	$I_{OUT} = 300\text{ mA}$		1.75	—	5.5	V
Line regulation	Reg·line	$V_{OUT} + 0.5\text{ V} \leq V_{IN} \leq 5.5\text{ V}$, $I_{OUT} = 1\text{ mA}$		—	1	15	mV
Load regulation	Reg·load	$1\text{ mA} \leq I_{OUT} \leq 300\text{ mA}$		—	8	35	mV
Quiescent current	I_B	$I_{OUT} = 0\text{ mA}$	$V_{OUT} = 1.0\text{ V}$	—	65	—	μA
			$V_{OUT} = 1.8\text{ V}$	—	65	—	
			$V_{OUT} = 2.5\text{ V}$	—	68	—	
			$V_{OUT} = 4.5\text{ V}$	—	78	125	
Stand-by current	I_B (OFF)	$V_{CT} = 0\text{ V}$		—	0.1	1	μA
Drop-out voltage	$V_{IN}-V_{OUT}$	$I_{OUT} = 300\text{ mA}$ (Note 3)		—	195	275	mV
Temperature coefficient	TC_{VO}	$-40^\circ\text{C} \leq T_{opr} \leq 85^\circ\text{C}$		—	75	—	ppm/ $^\circ\text{C}$
Output noise voltage	V_{NO}	$V_{IN} = V_{OUT} + 1\text{ V}$, $I_{OUT} = 10\text{ mA}$, $10\text{ Hz} \leq f \leq 100\text{ kHz}$, $T_a = 25^\circ\text{C}$ (Note 3)		—	38	—	μV_{rms}
Ripple rejection ratio	R.R.	$V_{IN} = V_{OUT} + 1\text{ V}$, $I_{OUT} = 10\text{ mA}$, $f = 1\text{ kHz}$, $V_{Ripple} = 500\text{ mV}_{p-p}$, $T_a = 25^\circ\text{C}$ (Note 3)		—	70	—	dB
Load transient response	ΔV_{OUT}	$I_{OUT} = 1 \Rightarrow 300\text{ mA}$, $C_{OUT} = 1.0\text{ }\mu\text{F}$		—	± 80	—	mV
Control voltage (ON)	V_{CT} (ON)	—		1.0	—	5.5	V
Control voltage (OFF)	V_{CT} (OFF)	—		0	—	0.4	V

Note 2: Stable state with fixed I_{OUT} condition.

Note 3: The 2.5 V output product.

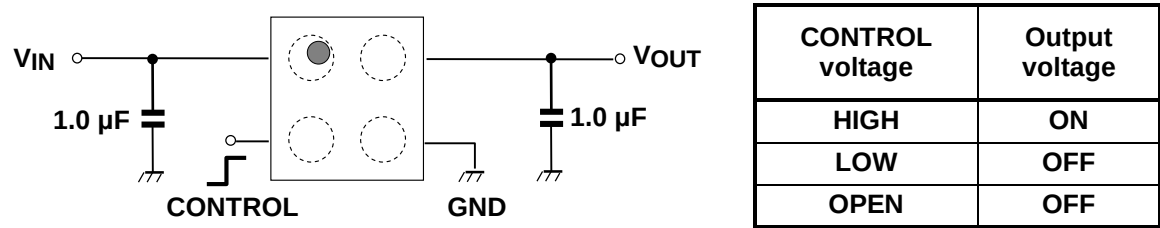
Drop-out voltage

($I_{OUT} = 300\text{ mA}$, $C_{IN} = 1.0\text{ }\mu\text{F}$, $C_{OUT} = 1.0\text{ }\mu\text{F}$, $T_a = 25^\circ\text{C}$)

Output voltages	Symbol	Min	Typ.	Max	Unit
1.0 V, 1.05 V	$V_{IN}-V_{OUT}$	—	570	750	mV
1.1 V		—	530	650	
1.2 V		—	470	600	
1.3 V		—	430	550	
1.35V		—	390	530	
1.4 V		—	370	520	
$1.5\text{ V} \leq V_{OUT} < 1.8\text{ V}$		—	330	450	
$1.8\text{ V} \leq V_{OUT} < 2.1\text{ V}$		—	250	365	
$2.1\text{ V} \leq V_{OUT} < 2.5\text{ V}$		—	220	315	
$2.5\text{ V} \leq V_{OUT} < 2.8\text{ V}$		—	190	275	
$2.8\text{ V} \leq V_{OUT} < 3.2\text{ V}$		—	180	235	
$3.2\text{ V} \leq V_{OUT} < 3.6\text{ V}$		—	160	215	
$3.6\text{ V} \leq V_{OUT} \leq 4.5\text{ V}$		—	130	185	

Application Note

1. Recommended Application Circuit

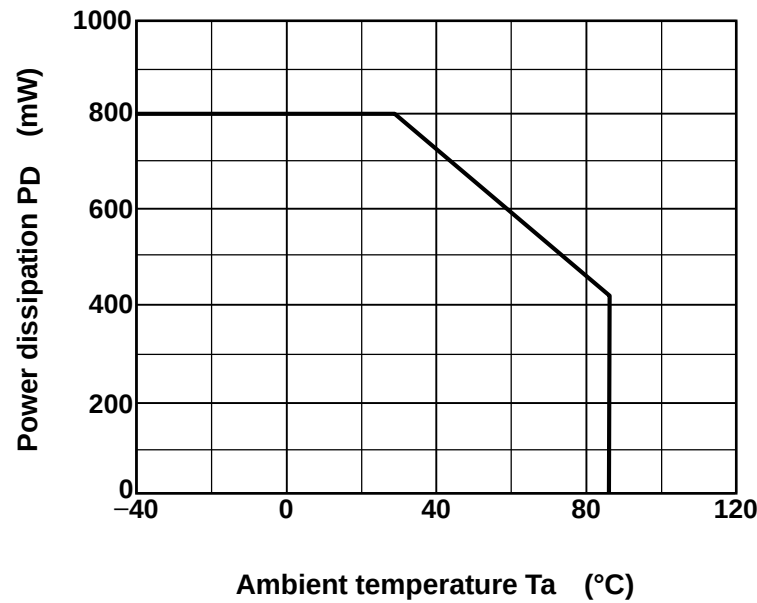


The figure above shows the recommended configuration for using a Low-Dropout regulator. Insert a capacitor at VOUT and VIN pins for stable input/output operation. (Ceramic capacitors can be used).

2. Power Dissipation

Board-mounted power dissipation ratings for TCR3DG series are available in the Absolute Maximum Ratings table. Power dissipation is measured on the board condition shown below.

[The Board Condition]
Board material: Glass epoxy(FR4)
Board dimension: 40mm x 40mm (both sides of board), t= 1.6mm
Metal pattern ratio: a surface approximately 50%, the reverse side approximately 50%
Through hole: diameter 0.5mm x 24



Attention in Use● **Output Capacitors**

Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommend the ESR of ceramic capacitor is under 10 Ω . For stable operation, please use over 1.0 μ F.

● **Mounting**

The long distance between IC and output capacitor might affect phase assurance by impedance in wire and inductor. For stable power supply, output capacitor need to mount near IC as much as possible. Also VIN and GND pattern need to be large and make the wire impedance small as possible.

● **Power Dissipation**

Please have enough design patterns for expected maximum power dissipation. And under consideration of surrounding temperature, input voltage, and output current etc, we recommend proper dissipation ratings for maximum power dissipation; in general maximum dissipation rating is 70 to 80 percent.

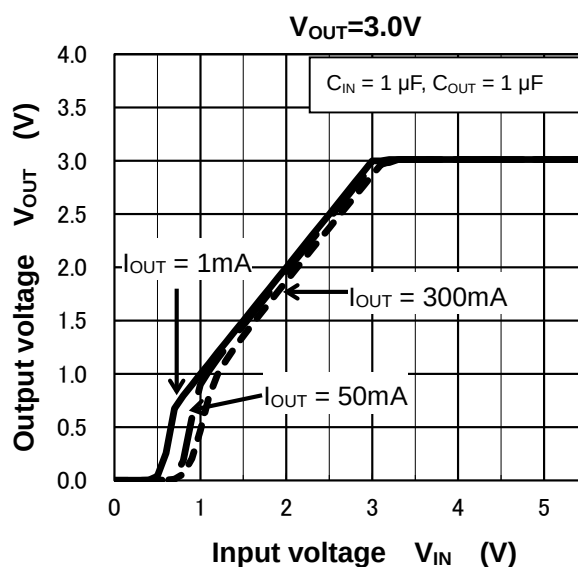
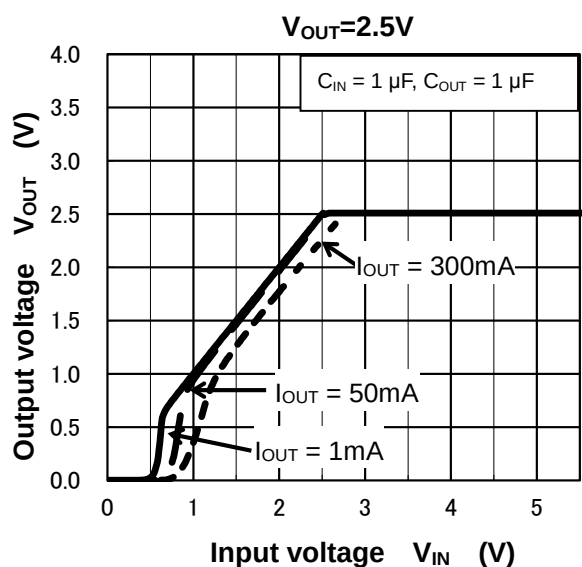
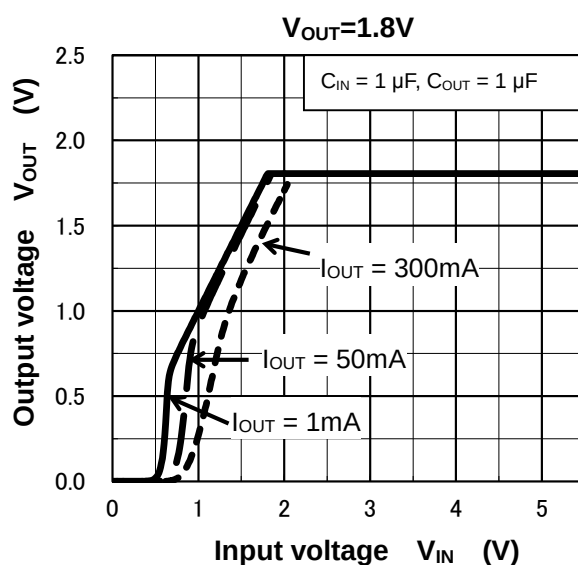
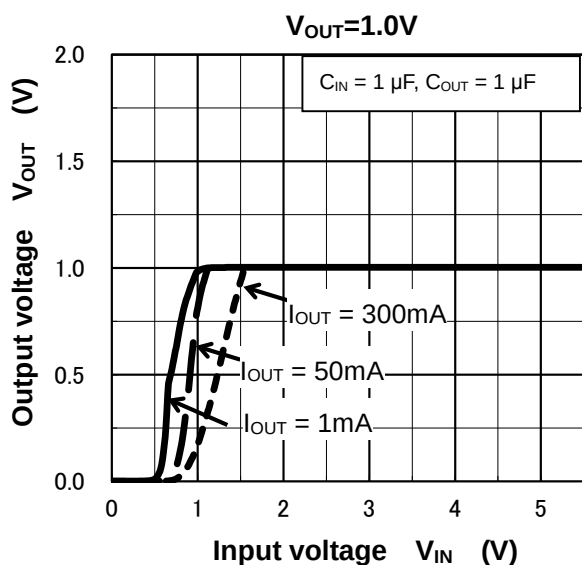
● **Over current Protection and Thermal shut down function**

Over current protection and Thermal shut down function are designed in these products, but these are not designed to constantly ensure the suppression of the device within operation limits. Depending on the condition during actual usage, it could affect the electrical characteristic specification and reliability. Also note that if output pins and GND pins are not completely shorted out, these products might be break down.

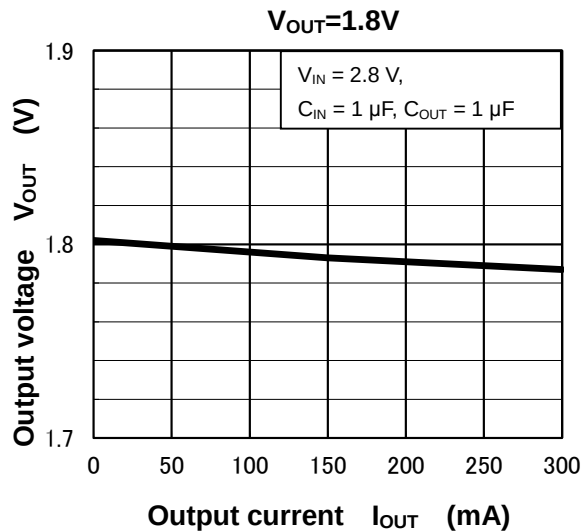
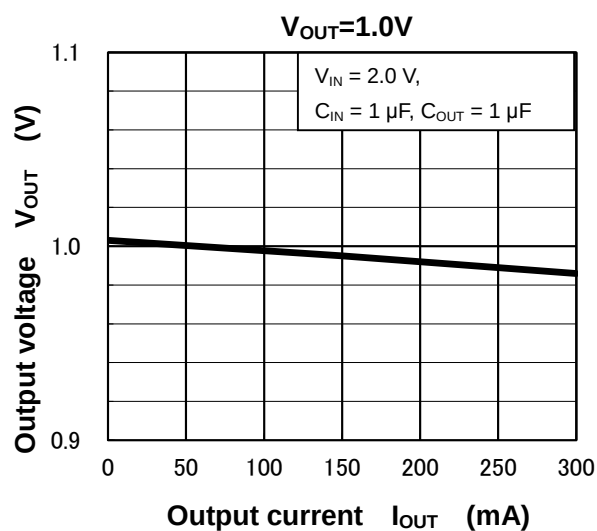
When using these products, please read through and understand the concept of dissipation for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommend inserting failsafe system into the design.

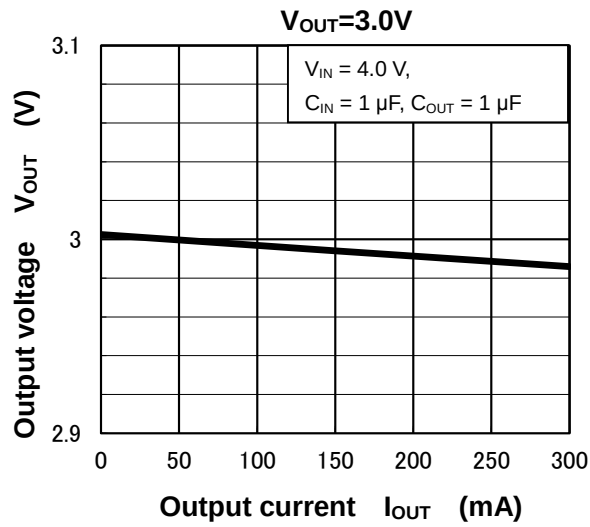
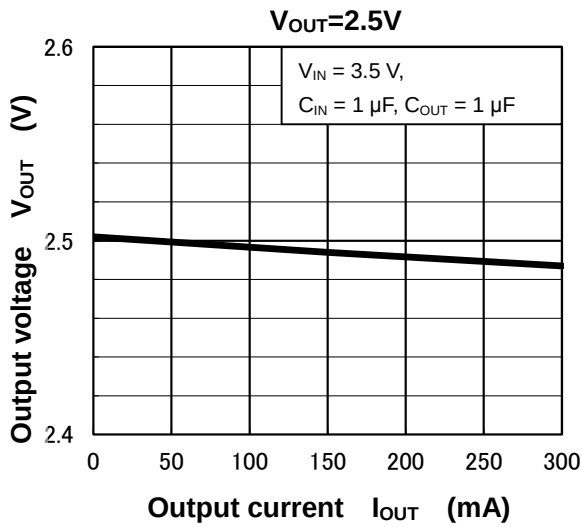
Representative Typical Characteristics

Output Voltage vs. Input Voltage

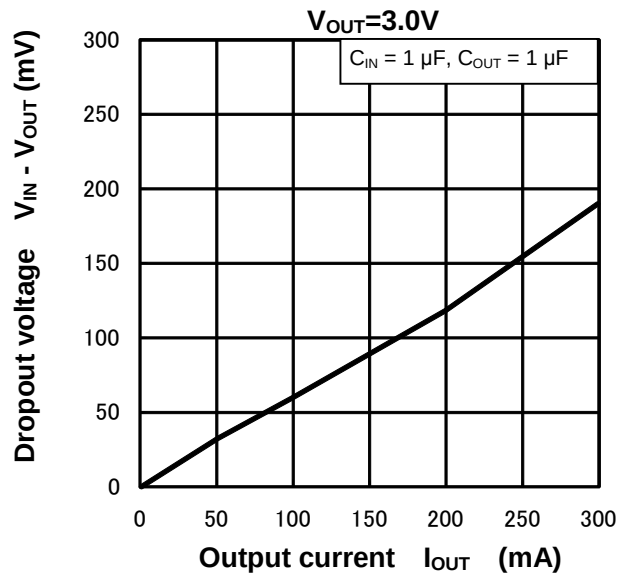
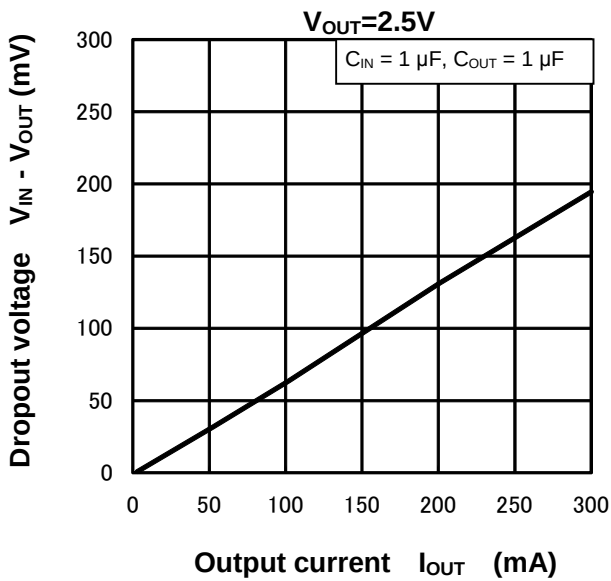
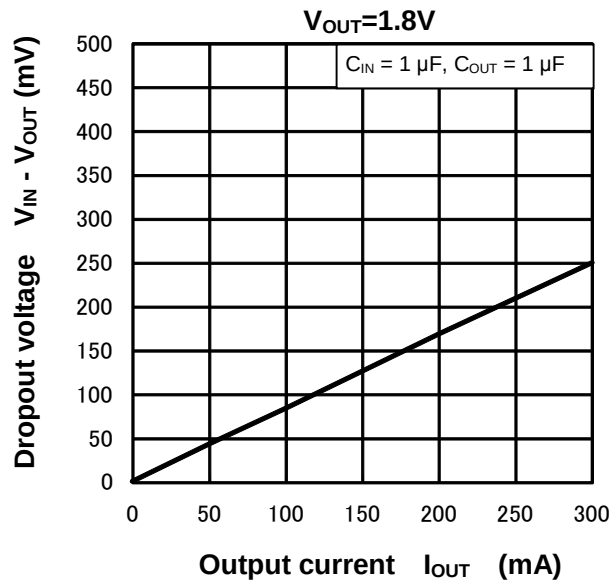
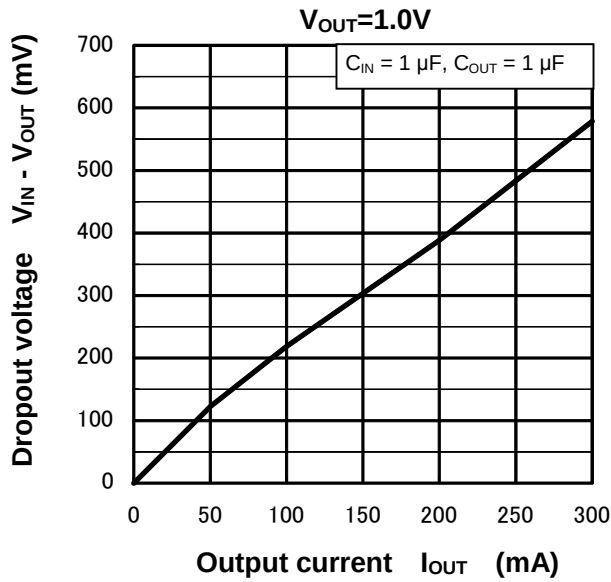


Output Voltage vs. Output Current

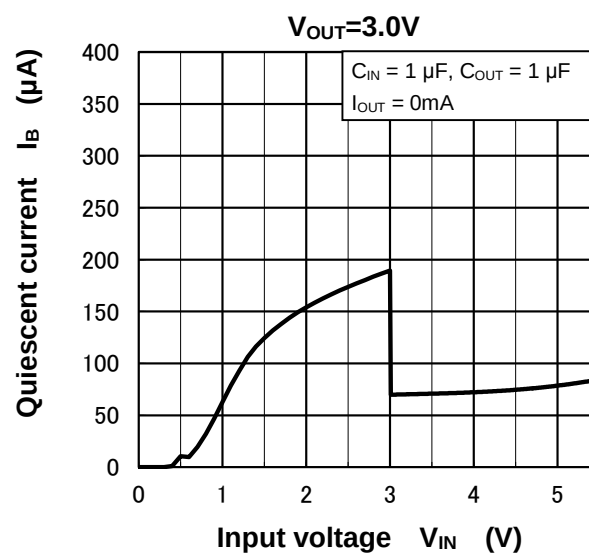
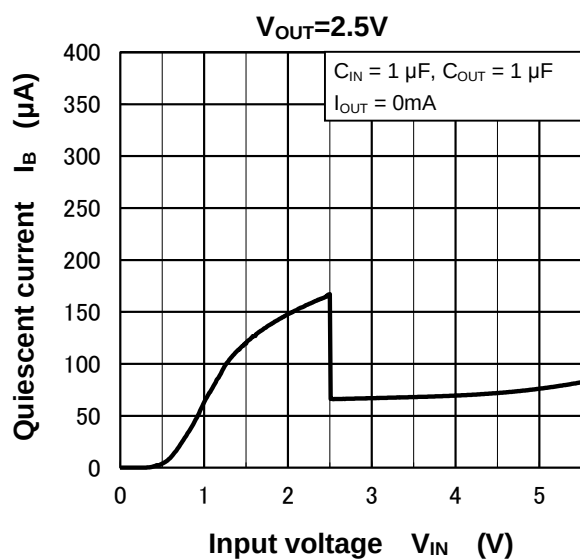
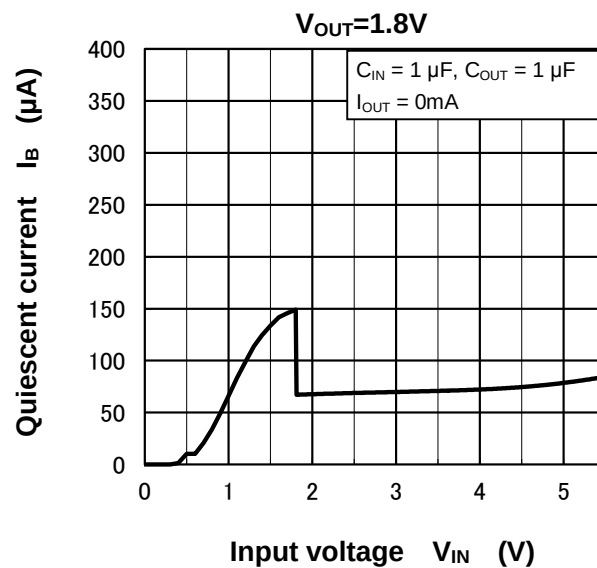
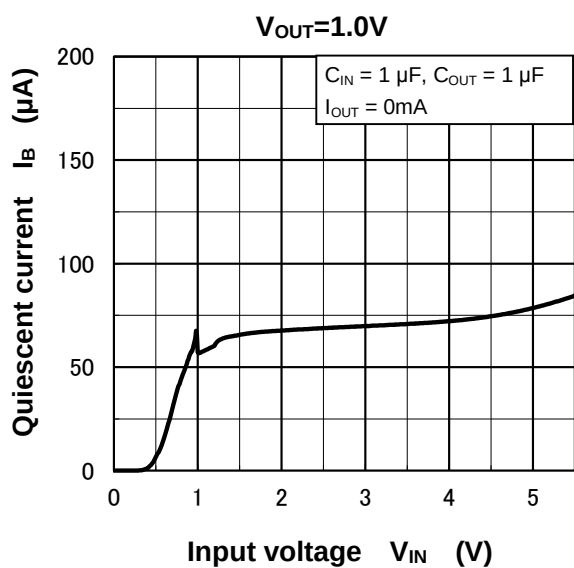




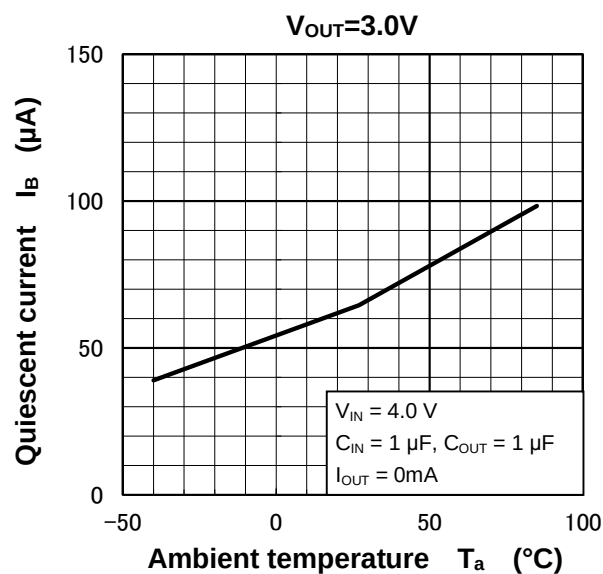
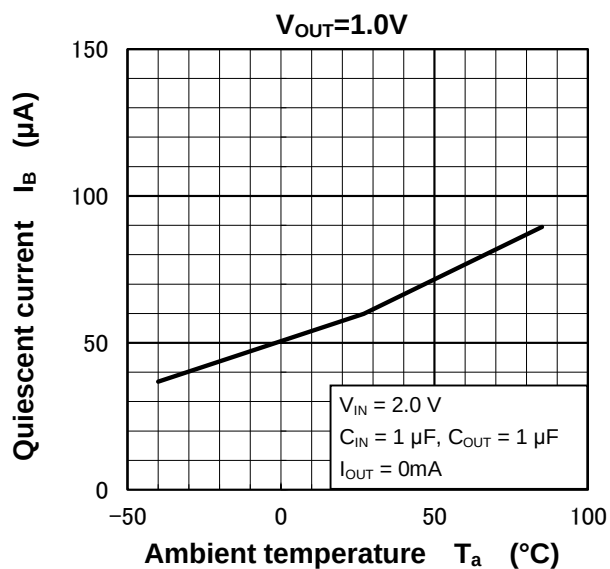
Dropout Voltage vs. Output Current



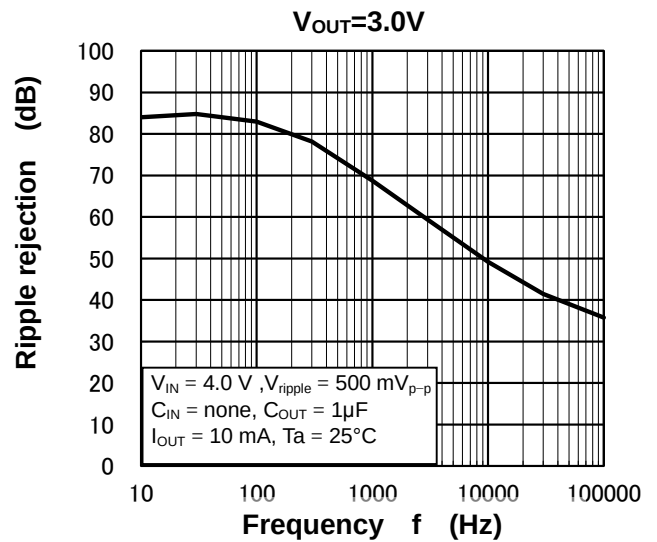
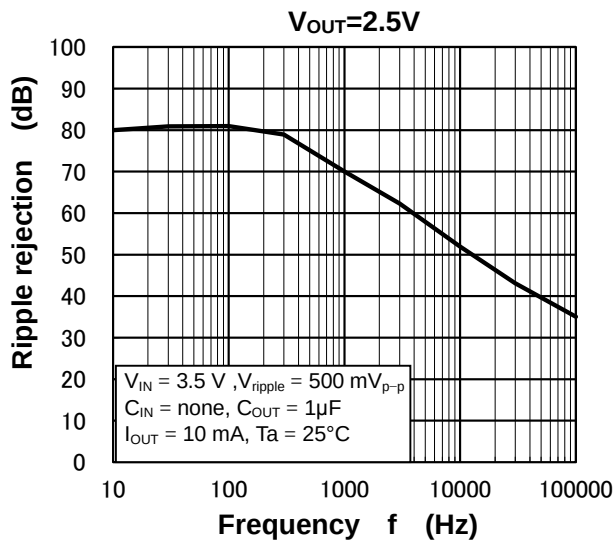
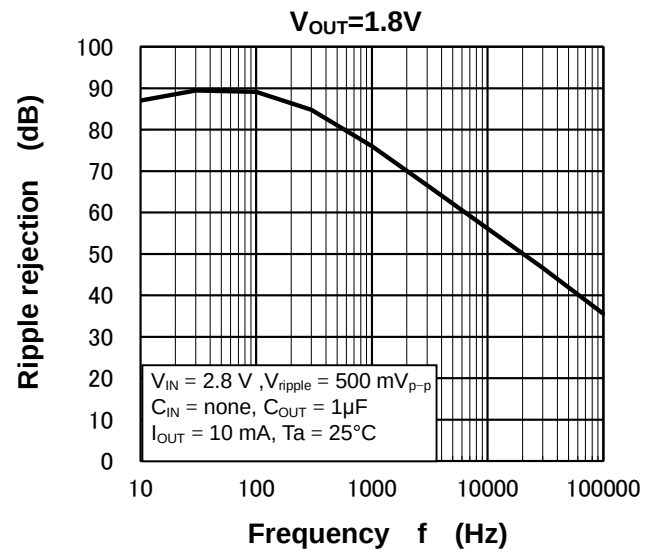
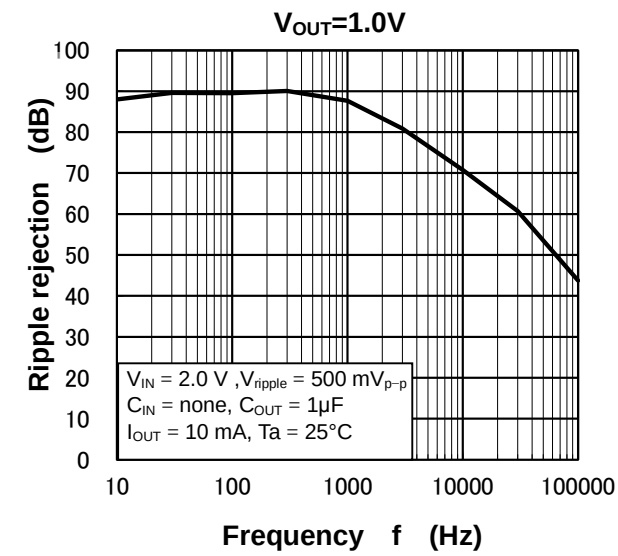
Quiescent Current vs. Input Voltage



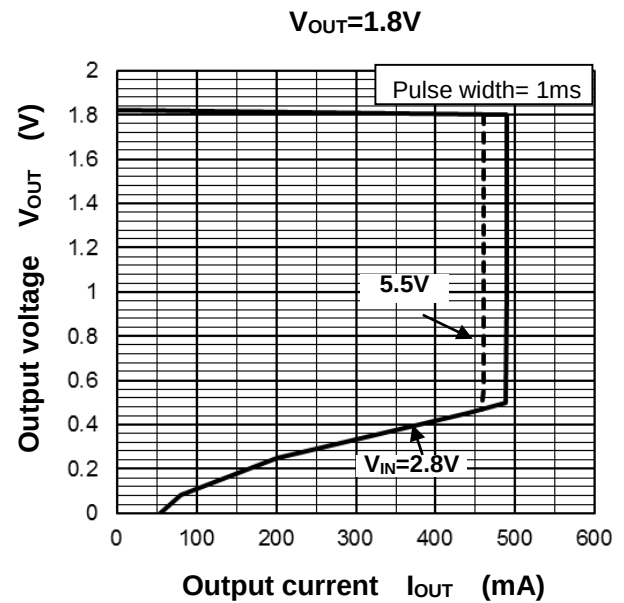
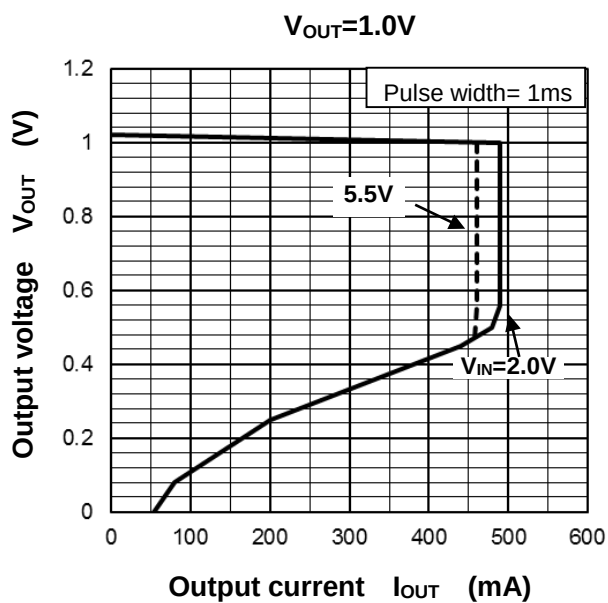
Quiescent Current vs. Ambient Temperature

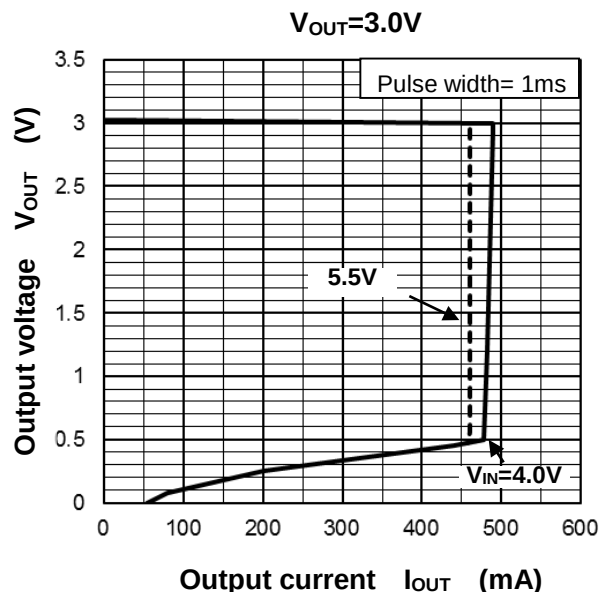
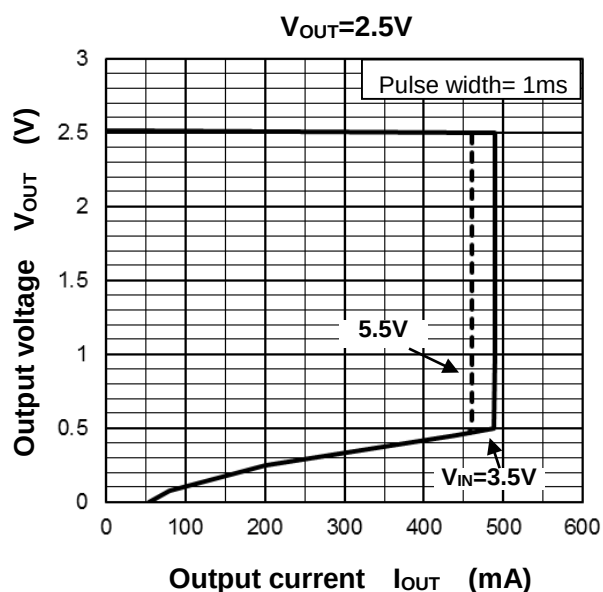


Ripple Rejection Ratio vs. Frequency

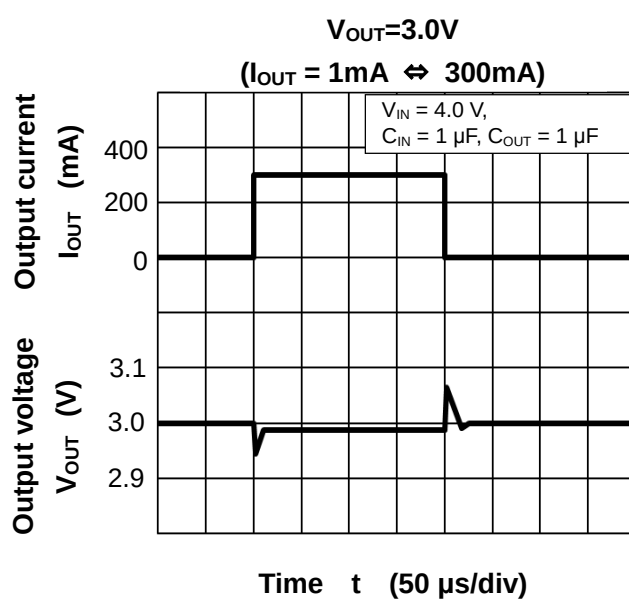
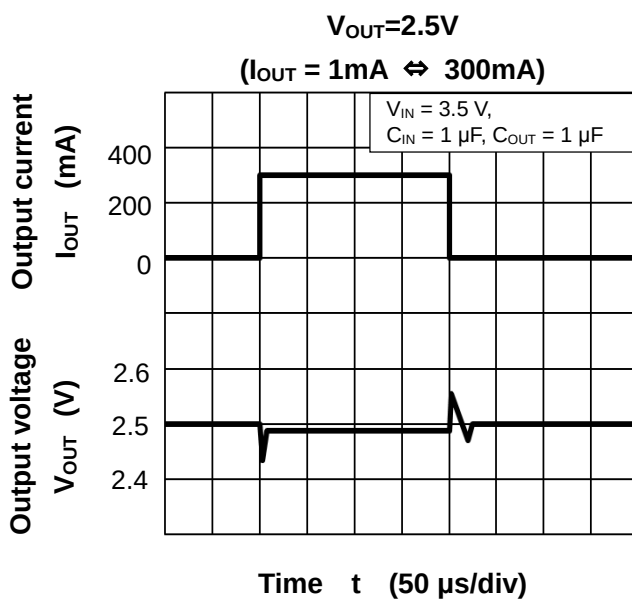
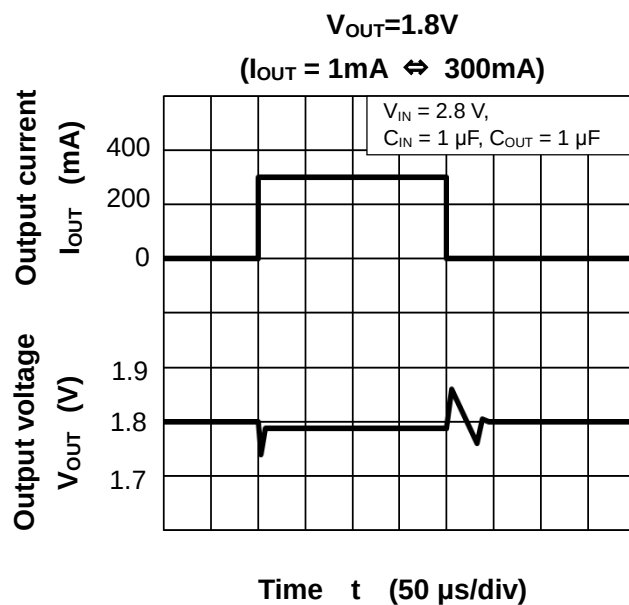
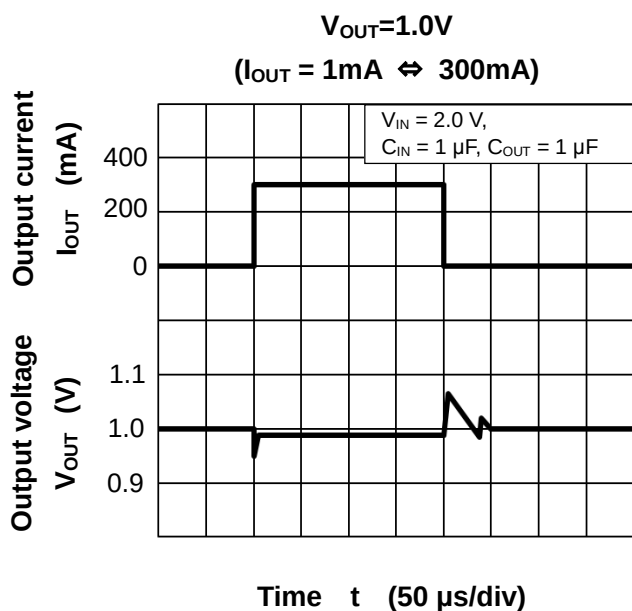


Output Voltage vs. Output Current

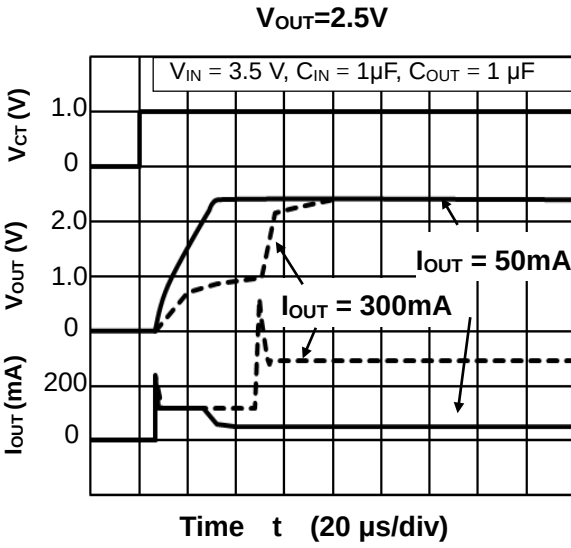
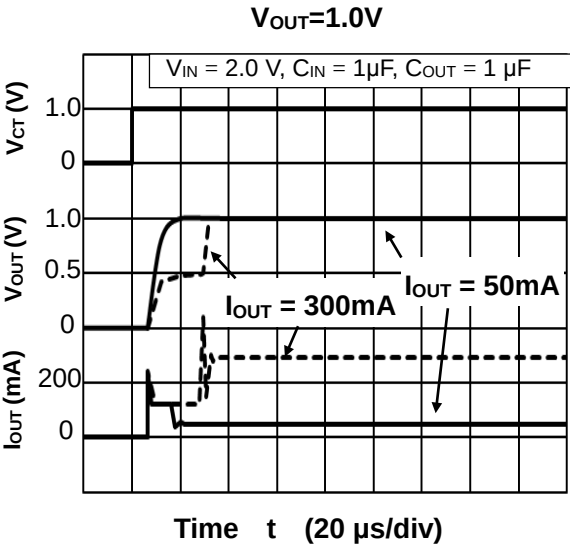




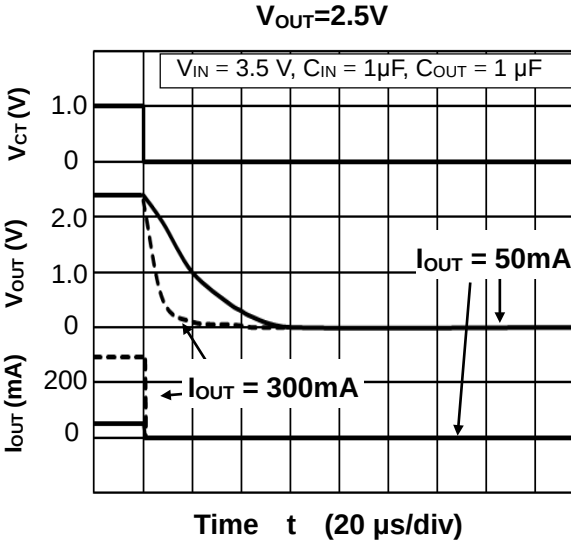
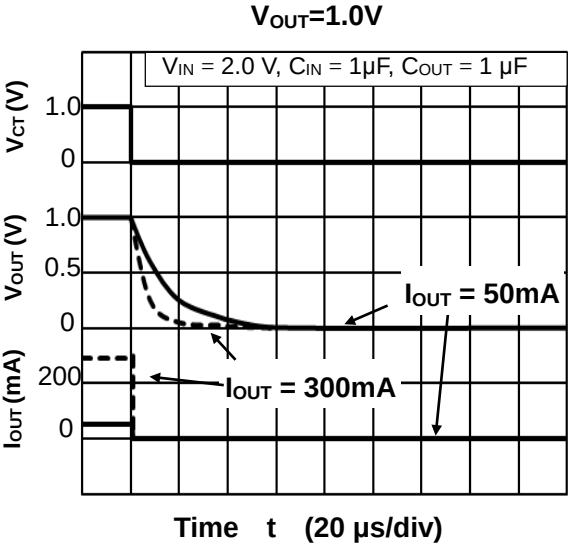
Load Transient Response



t_{ON} Response



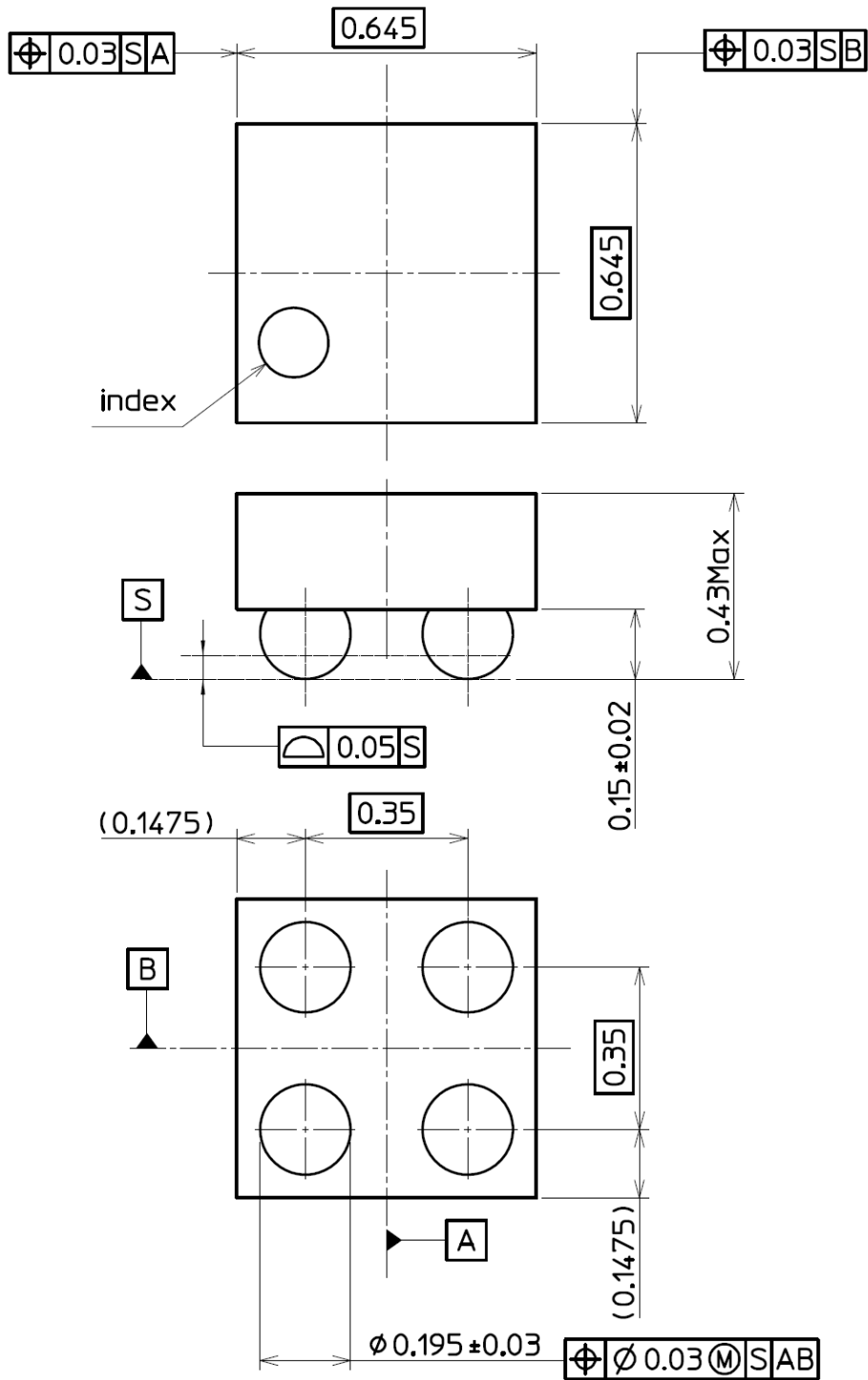
t_{OFF} Response



Package Dimensions

WCSP4E

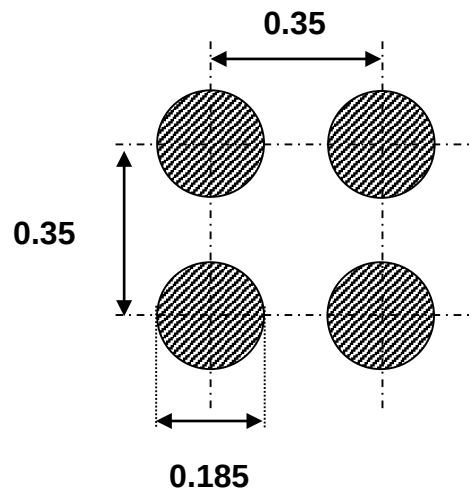
Unit: mm



Weight : 0.34mg(Typ)

Land pattern dimensions for reference only

Unit: mm



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